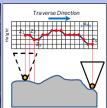
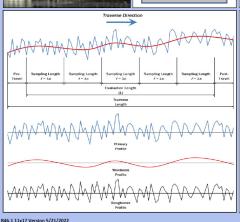


B46.1 - 2019 : Surface Roughness, Waviness, and Lay Basic Terms







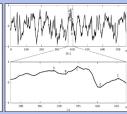
Measurement of Surfaces

Stylus instruments are commonly used to measure surface roughness and waviness. stylus of a known tip radius is moved across a surface at a fixed speed. As the stylus follows the irregularities in the surface, height data $(Z_1, Z_2, Z_3, ... Z_N)$ is recorded at a given sampling interval, d_0 . The height data can then be filtered to level the profile, remove the underlying form, and separate short wavelengths (roughness) from longer wavelengths (voighness).

Aspect Ratio — Section 1-3.1.1

In displays of surface profiles generated by instruments, heights are

In displays of surface profiles generated by instruments, heights are usually magnified many times more than the distances along the profile. The sharp peaks, valleys, and the steep slopes seen on such profile representations of surfaces are thus greatly distorted images of the relatively gentle slopes characteristic of actual measured profiles.



Definitions — Sections 1-2.1, 1-2.2, 1-3.1, & 1-3.5

Surface: The boundary that separates an object from another object, substance, or space

Error of Form: Widely spaced deviations of the real surface from the nominal surface which are not included in surface texture.
Form Suppressed Profile: A modified profile obtained by various techniques to attenuate dominant form such as curvature or tilt.

Waviness: The more widely spaced component of the surface texture. The waviness profile is the modified profile obtained by filtering

to attenuate the shorter spatial wavelengths associated with roughness and the longer spatial wavelengths associated with form.

Roughness: The finer spaced irregularities of the surface texture that usually result from the inherent action of the production process or material condition. The roughness profile is the modified profile obtained by filtering to attenuate the longer spatial wavelengths associated with waviness.

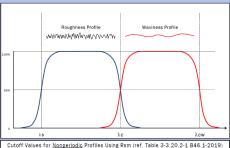
Lay: The predominant direction of the surface pattern, ordinarily determined by the production method used.

- Profiling instruments sample surface height data over a specific distance, consisting of several different lengths:

 Traverse Length: This is the total length of travel of the instrument on the surface. Due to end effects, the traversing length must
- be longer than the evaluation length.
- Evaluation Length (L): Length used to evaluate the profile, after discarding a given distance at the beginning and end of the profile
 to account for end effects.
- Sampling Length (ℓ): Length in the direction of the X-axis used for identifying the widest irregularities that are of interest for the profile. When an electrical or digital filter is used, the roughness long wavelength cutoff value determines and is equal to the roughness sampling length (i.e. $f = \lambda c$)



B46.1 - 2019 : Surface Roughness, Waviness, and Lay Filtering, Ra, and Wt



ı	۸.5		ΛÜ	λCW	
ĺ	Cutoff Values for Nonperiodic Profiles Using Rsm (ref. Table 3-3.20.2-1 B46.1-20				
ı	Ra [µm]		Cutoff Length - λc [mm]	Evaluation Length - L [mm]	
ı	Over	Up To	Cutori Lengtii - Ac (inini)	Evaluation Length - L [mm]	
ı	***	0.02	0.08	0.40	
ı	0.02	0.10	0.25	1.25	
ı	0.10	2.0	0.80	4.0	
ı	2.0	10.0	2.5	12.5	
ı	10.0	***	8.0	40.0	
ı	Cutoff Values for Periodic Profiles Using Ra (ref. Table 3-3.20.1-1 B46.1-201				
ı	Rsm [mm]		Cutoff Length - λc [mm]	Evaluation Length - L [mm]	
ш			Outon congtil - At [IIIII]	Evaluation Length - L [illin]	

	10.0	***	8.0	40.0	
Cutoff Values for Periodic Profiles Using Ra (ref. Table 3-3.20.1-1 B4					
	Rsm [mm]		Cutoff Length - λc [mm]	Evaluation Length - L [mn	
	Over	Up To	Outon Length - Ac [mm]	Evaluation Length - E [iiiii	
	0.01	0.04	0.08	0.40	
	0.04	0.13	0.25	1.25	
	0.13	0.40	0.80	4.0	
	0.40	1.3	2.5	12.5	
	1.3	4.0	8.0	40.0	
	Note: Values div	an are duidelines	for cases where the roughness filts	ar cutoff langth is not enacified	

on the drawing

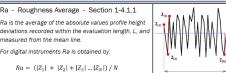
Section 1-3.5 Measurement and Analysis Lengths

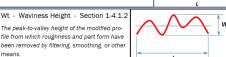
Filtering is required to separate long wavelengths (waviness) from short wavelengths (roughness).

- Roughness Long Wavelength Cutoff (\(\lambda c \)): Attenuates longer wavelengths to yield the roughness profile.
- Roughness Short Wavelength Cutoff (\(\lambda \)): Shorter wavelengths are attenuated to remove fine asperities or noise from the roughness profile.
 Waviness Long Wavelength Cutoff (\(\lambda \) \text{CMD} : Attenuates longer wavelengths to september 1.
- rate waviness from form. Waviness Short Wavelength Cutoff (λ sw) : Shorter wavelengths are attenuated to
- separate waviness from roughness. Generally set equal in value to the corresponding roughness long wavelength cutoff (λ sw = λ c).

How do filter settings affect roughness parameters?

Changing the filter settings shifts profile height data from the roughness to the waviness domain, depending on what is of interest to the user. If the filter settings are not given on the drawing, guidelines are provided in section 3-3.20 of B46.1-2019.





The charts below show how changing the filter cutoff changes what is considered roughness
(represented by the black line) and waviness
(represented by the red line). As \(\lambda \) is reduced, the
height deviations considered roughness become
smaller and the Ra is reduced while the waviness
(Wt) increases. Filter settings can \(\text{significantly impact \(\text{roughness} \) and \(\text{waviness} \) values and it is critical that the user understand the requirements of
the surface and how it should be measured and
analyzed.

